# Clock OSC

# SG7050VAN

Product name SG7050VAN 700.000000MHz KEGA Product Number / Ordering code

X1G0042810038xx

Please refer to the 9.Packing information about xx (last 2 digits)

Output waveform LVDS

Pb free / Complies with EU RoHS directive

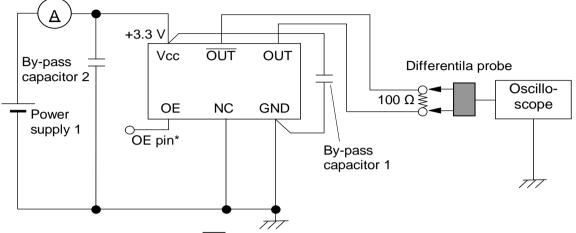
Reference weight Typ. 149 mg

<b>1.Absolute maximum ratings</b>						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks
Maximum supply voltage	Vcc-GND	-0.3	-	+4	V	-
Storage temperature	T_stg	-40	-	+125	°C	Storage as single product
Input voltage	Vin	-0.3	-	Vcc+0.3	V	OE Terminal

2.Specifications(character	istics)					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks
Output frequency	fO	-	700.0000	-	MHz	
Supply voltage	Vcc	2.25	-	3.63	V	-
Operating temperature	T_use	-40	-	+85	°C	-
Frequency tolerance	f_tol	-30	-	30	x10 <sup>-6</sup>	-
Current consumption	lcc	-	-	30	mA	OE = Vcc, L_LVDS = 100 $\Omega$
Stand-by current	I_std	-	-	-	mA	-
Disable current	I_dis	-	-	20.0	mA	OE = GND
Symmetry	SYM	45	-	55	%	At output crossing point
Output voltage(LVDS)	Vod	250	-	450	mV	-
	dVod	-	-	50	mV	]-
	Vos	1.15	-	1.35	V	]-
	dVos	-	-	150	mV	]-
Output load condition(LVDS)	L_LVDS	-	100	-	Ω	Connected between OUT and $\overline{OUT}$
Input voltage	V <sub>IH</sub>	70 % Vcc	-	-		-
	V <sub>IL</sub>	-	-	30 % Vcc		]-
Rise time	t <sub>r</sub>	-	-	300	ps	-
Fall time	tf	-	-	300	ps	-
Start-up time	t_str	-	-	3	ms	-
Jitter	t <sub>DJ</sub>	-	6.2	-	ps	Deterministic Jitter Vcc=2.5V
	T <sub>RJ</sub>	-	1	-	ps	Random Jitter Vcc=2.5V
	t <sub>RMS</sub>	-	2.2	-	ps	δ(RMS of total distribution) Vcc=2.5V
	t <sub>p-p</sub>	-	15.9	-	ps	Peak to Peak Vcc=2.5V
	t <sub>acc</sub>	-	1	-	ps	Accumulated Jitter( $\delta$ ) n=2 to 50000 cycles Vcc=2.5V
Phase jitter	t <sub>PJ</sub>	-	0.4	-	ps	Offset Frequency: 12kHz to 20MHz Vcc=2.5V
Phase noise	L(f)	-	-29	-	dBc/Hz	Offset 1Hz Vcc=2.5V
		-	-64	-	dBc/Hz	Offset 10Hz Vcc=2.5V
		-	-94	-	dBc/Hz	Offset 100Hz Vcc=2.5V
		-	-107	-	dBc/Hz	Offset 1kHz Vcc=2.5V
		-	-117	-	dBc/Hz	Offset 10kHz Vcc=2.5V
		-	-123	-	dBc/Hz	Offset 100kHz Vcc=2.5V
		-	-122	-	dBc/Hz	Offset 1MHz Vcc=2.5V
Frequency aging	f_age	-5	-	5	x10 <sup>-6</sup> /Year	25 °C, 1st year
		-	-	-		-

#### 3.Test circuit

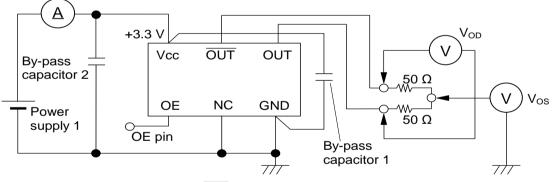
1) To observe waveform and current (case 1)



\* The lines from OUT and OUT pin are same length.

\* To measure the disable current, OE pin is connected to GND

2) To observe waveform and current (case 2)



\* The lines from OUT and  $\overline{OUT}$  pin are same length.

### 3) Measurement condition

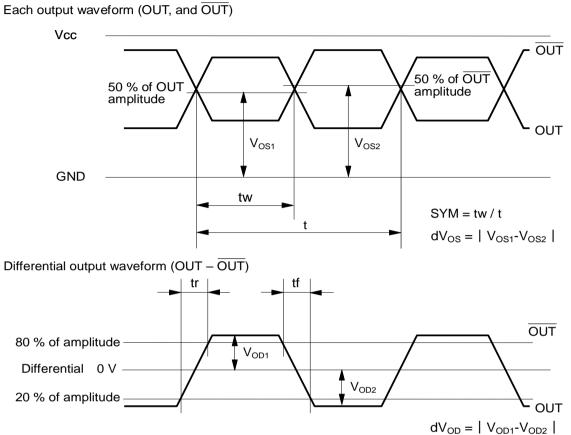
A) Oscilloscope

•Bandwidth should be 5 times higher than DUT's output frequency (4 GHz).

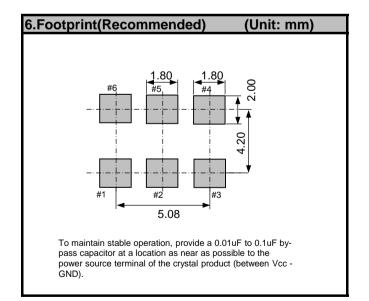
•Probe ground should be placed closely from test point and lead length should be as short as possible.

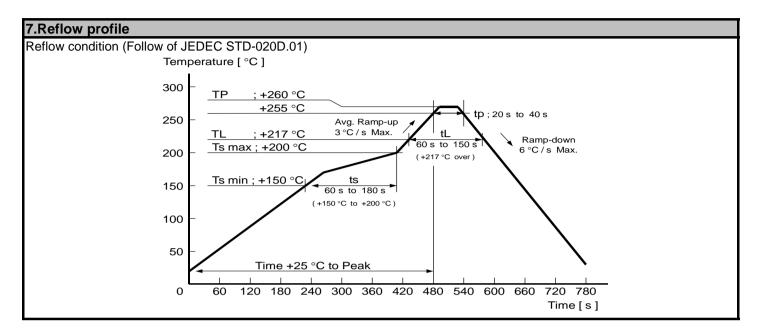
- B) By-pass capacitor 1 (approx. 0.01  $\mu$ F to 0.1  $\mu$ F) places closely between Vcc and GND.
- C) By-pass capacitor 2 (approx. 10 µF) places closely between power supply terminals on the board.
- D) Use the current meter whose internal impedance value is small.
- E) Power supply
- Start up time (0 Vg90 %Vcc) of power source should be more than 150  $\mu s$  and slew rate should be less than 19.8 mV/ $\mu s.$
- Impedance of power supply should be as low as possible.





5.E	xternal dimension	IS	(Unit: mm)			
	7.0±0.2	1.4±0.2				
	#6 #5 #4		Pin	Connection		
0.2	007050		1	OE N.C.		
5.0±0.2	SG7050		3	GND		
1	#1 #2 #3		4	OUT		
		4	5			
2.6 1.1	5.08 #1 C0.4					
<b>↓</b> [	<ul> <li>CE pin = "H" or "open" : Specified frequency output</li> <li>DE pin = "L" : Output is high impedance.</li> <li>#2 pin connection = GND is acceptable.</li> <li>The metal cap is connected to #3 pin.</li> </ul>					



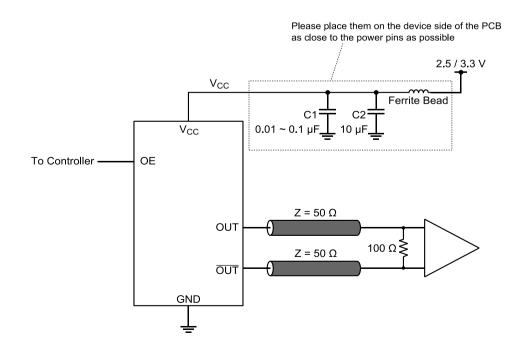


8.Example of schematic layout

This figure shows an example of this product's application schematic.

As with any high speed analog circuitry, the power supply pins for this device are vulnerable to noise. In order to achieve optimum jitter performance, power isolation with filter device is required for power supply pins.

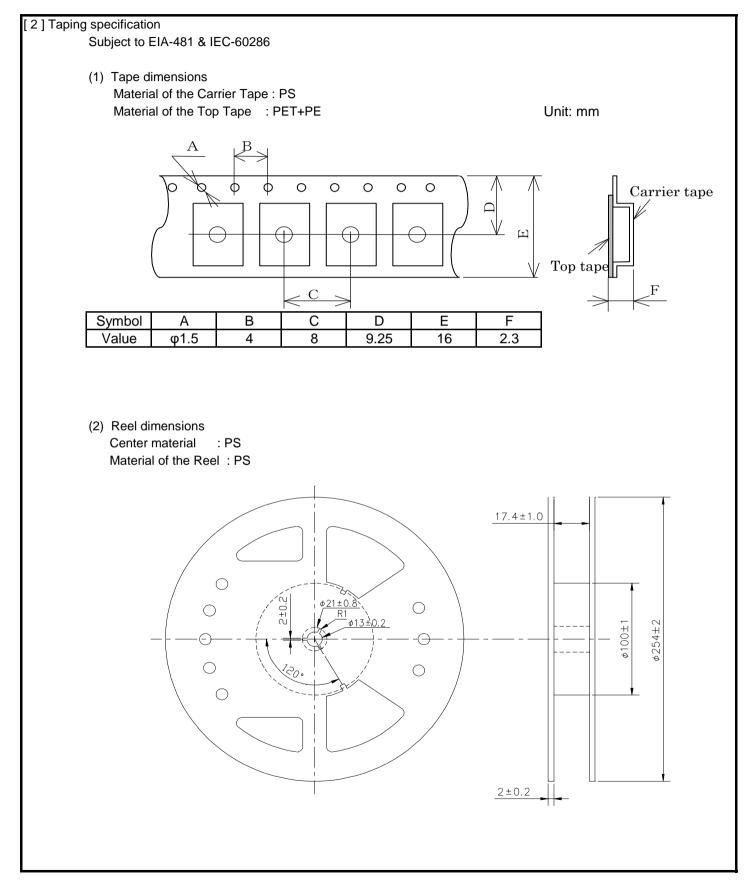
In order to achieve best performance of the power isolation filter, it is recommended that the filter composing devices is placed on the device side of the PCB as close to the power pins as possible. The component value of this filter is just an example, it may have to be adjusted.



\* By-pass capacitor (approx. 0.01  $\mu$ F to 0.1  $\mu$ F) places closely between Vcc and GND. \* By-pass capacitor (approx. 10  $\mu$ F) places closely between power supply terminals on the board. \* Please design the two output lines by characteristic impedance 100  $\Omega$  and same length, and try to make the output lines as short as possible.

# 9.Packing information

1 ]Product number last 2 digits code(xx) description		The recommended code is "00"		
	X1G0042	810038xx		
	Code	Condition	Code	Condition
	01	Any Q'ty vinyl bag(Tape cut)	13	500pcs / Reel
	11	Any Q'ty / Reel	00	1000pcs / Reel
	12	250pcs / Reel		



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